# **High Density**

# 17 BH/HD Series

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### **SPECIFICATIONS:**

## MATERIALS AND PLATINGS

#### Shells

Contact Material Contact Plating

Termination End

Nickel Underplate

Steel, tin plated, grounding indents on plug. Copper alloy Engagement area: gold (see ordering information). 150µ" (3.81µm) tin/lead 50µ" (1.27µm) entire contact

## **ELECTRICAL DATA**

Current Rating3 Amps maximum perVoltage Rating125 VACDielectric Withstanding Voltage1000 VAC (minimum)DielectricGlass filled thermoplasblackLH 94 VO

3 Amps maximum per contact 125 VAC 1000 VAC (minimum) Glass filled thermoplastic, black, UL 94 VO 5,000 Megaohms (minimum) 15 Milliohms (maximum)

# CLIMATIC DATA

**Insulation Resistance** 

**Contact Resistance** 

**Operating Temperature** 

-67°F (-55°C) to 221°F (105°C)

Amphenol's High Density D-Subminiature connectors compleme nt Amphenol's extensive D-Subminiature connector line. This line of connectors offers many superior features, high performance level and low installation cost.

The connector configurations are available in 15, 26, 44, 62 and 78 positions.

The product offering includes PCB mount connectors in both straight or right angle termination styles. Straight PCB mount are available in both Fixed Screw Machine and Stamped and Formed contacts, while Right Angle PCB mount are only available with Stamped and Formed contacts.

A cable mount version with solder terminations is also available, which can be combined with Amphenol's standard line of shielded or unshielded backshells.

> Industrial
> Telecom
> Any industry standard I / O connections

INCHES (MM)

# High Density Solder Cup And Straight P.C. Mount / Double Metal Shell Fixed Contact



## ORDERING INFORMATION



INCHES (MM)